PIN Diode Shunt Switch Element



MSWSH-040-30

Rev. V2

Features

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- Supports up to 40 W Power
 - Low Insertion Loss: 0.10 dB to 2.7 GHz 0.25 dB to 6.0 GHz
- High Isolation: 26 dB to 6.0 GHz
- RoHS* Compliant

Applications

- Wireless Telecommunications Infrastructure
- Test Instrument Applications

Description

A broadband, high linearity, medium power shunt switch element in a 1.9 x 1.1 mm DFN package.

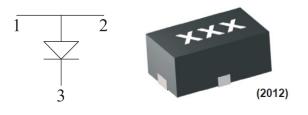
This device is designed for wireless telecommunications infrastructure and test instrument applications. It is also suited for other applications in $0.05 \sim 6$ GHz.

Electrical Specifications: $T_A = +25^{\circ}C$

Parameter **Test Conditions** Units Min. Тур. Max. V 500 Breakdown Voltage (V_B) $I_{R} = 10 \ \mu A$ Total Capacitance (C_T) V_R = -50 V, 1 MHz 0.42 pF Series Resistance (R_s) I_F = 100 mA, 500 MHz Ω 0.36 I-Region (W) 40 I-Layer mm $V_{R} = 10 V$ 2.7 GHz Insertion Loss (IL) 0.10 0.30 dB <6.0 GHz 0.30 0.50 $I_{F} = 100 \text{ mA}$ Isolation (I_{SO}) 2.7 GHz 29 32 dB <6.0 GHz 24 26 $V_{R} = 10 V$ 2.7 GHz Input / Output Return Loss (RL) 18 22 dB <6.0 GHz 15 13 Minority Carrier Lifetime (T_{L}) $I_F = 10 \text{ mA}, I_R = 6 \text{ mA}, @ 50\%$ 600 ns

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

Pin Out / Schematic



Ordering Information

Part Number	Package
MSWSH-040-30	3000 piece reel

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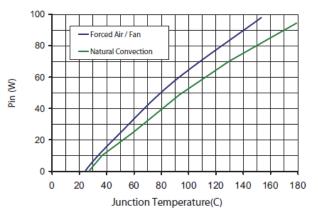


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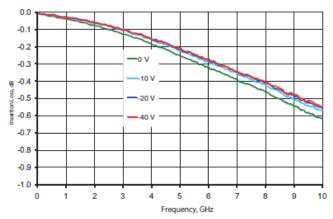
Absolute Maximum Ratings

Parameter	Absolute Maximum
Breakdown Voltage	500 V
Forward Current	500 mA
Thermal Resistance	10°C/W
Junction Temperature	+175°C
Storage Temperature	-65°C to +150°C
Assembly Temperature	+260°C Per JEDEC STD-J-20C

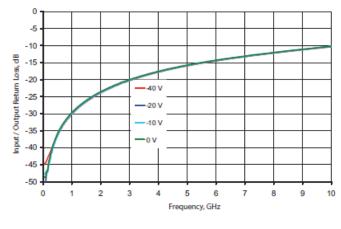
Junction Temperature vs. Power Mounted on Heatsink, +25°C, 1.3 GHz



Insertion Loss







Series Resistance vs. Bias, 500 MHz

3

4

5

Frequency, GHz

6

7

8

2

-10 mA

20 mA

40 mA

-50 mA

100 mA

Isolation

0.0

-5.0

-10.0

-15.0

-20.0 steps -25.0

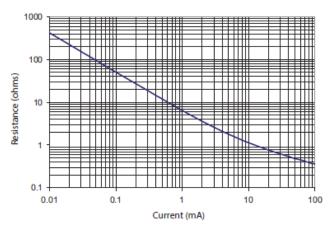
-30.0

-35.0

-40.0

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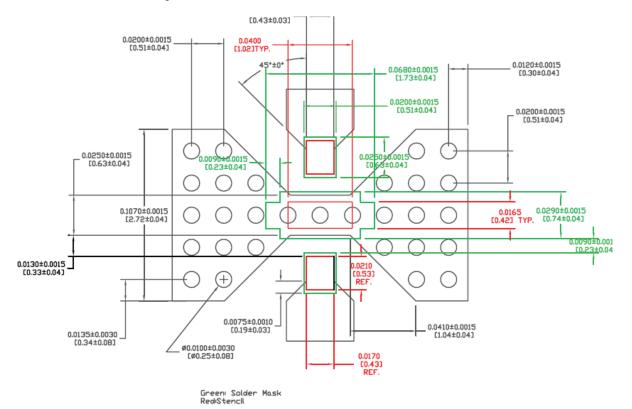
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Printed Circuit Board Layout



NOTE: If possible, use copper filled vias underneath pin 3 for better thermals; otherwise, use vias that are plated through, filled and plated over.

Solder mask should provide a 60 um clearance between copper pad and soldermask. Rounded pkg pads should have matching rounded solder mask openings.

Use circles or squares for the thermal land stencil such that only get 50% to 80% solder paste coverage.

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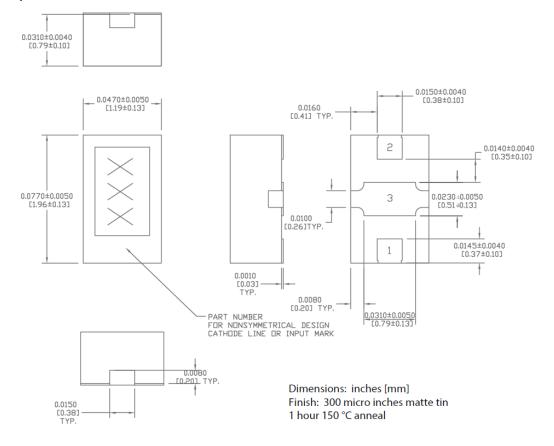
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Outline (2012)



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